

P-Channel 20-V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$	I _D (A)	Q _g (Typ.)			
- 20	0.0040 at V _{GS} = 10 V	- 52	21.5 nC			
	0.0060 at V _{GS} = 4.5 V	- 40	21.5110			

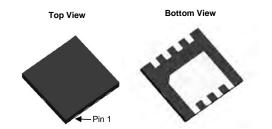
FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET[®] Power MOSFET
- 100 % R_a Tested
- Compliant to RoHS Directive 2002/95/EC

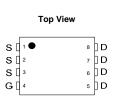


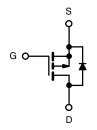
APPLICATIONS

- · Load Switch
- · Adaptor/Battery Switch



DFN 3x3 EP





P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unless otherwise noted)						
Parameter		Symbol	Limit	Unit		
Drain-Source Voltage		V_{DS}	- 20	V		
Gate-Source Voltage		V _{GS}	± 16	V		
	T _C = 25 °C		- 52			
Continuous Drain Current (T _J = 150 °C)	T _C = 70 °C	I _D	- 40 ^g			
Continuous Diam Current (1) = 150 °C)	T _A = 25 °C	טי	- 26 ^{b, c}			
	T _A = 70 °C		- 21 ^{b, c}	Α		
Pulsed Drain Current	I _{DM}	- 150				
Continuous Source-Drain Diode Current	T _C = 25 °C	Is	- 40 ^g			
Continuous Course Brain Blode Carrent	T _A = 25 °C	.5	- 4.5 ^{b, c}			
	T _C = 25 °C		54			
Maximum Power Dissipation	$T_C = 70 ^{\circ}C$	P _D	34.7	w		
Maximum Fower Dissipation	T _A = 25 °C	٠ ٥	5.0 ^{b, c}	**		
	T _A = 70 °C		3.2 ^{b, c}			
Operating Junction and Storage Temperature Rar	T _J , T _{stg}	- 55 to 150	°C			
Soldering Recommendations (Peak Temperature)		260)			

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{b, f}	t ≤ 10 s	R_{thJA}	20	25	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	R_{thJC}	1.8	2.3]	

Notes:

- a. Based on T_C = 25 °C.
- b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 10 s.



SPECIFICATIONS (T _J = 25 °C, unless otherwise noted)						
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static	.,			1		T
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0, I _D = - 250 μA	- 20			V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = - 250 цА		- 15		mV/°C
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	5 .		4.5		
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = -250 \mu\text{A}$	- 1		- 2.2	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 16 \text{ V}$			± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			- 1 - 10	μΑ
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le -20 \text{ V}, V_{GS} = -10 \text{ V}$	- 30		- 10	Α
On-State Drain Current	.D(ou)	$V_{GS} = -10 \text{ V}, I_{D} = -26 \text{ A}$		0.0040		- ^
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = -10 V, I _D = -20 A V _{GS} = -4.5 V, I _D = -21 A		0.0040		Ω
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 10 V, I _D = - 26 A		58		S
Dynamic ^b						
Input Capacitance	C _{iss}			4595		pF
Output Capacitance	C _{oss}	V _{DS} = - 10 V, V _{GS} = 0 V, f = 1 MHz		910		
Reverse Transfer Capacitance	C _{rss}	, Bo		813		
·		V _{DS} = - 10 V, V _{GS} = - 10 V, I _D = - 20 A		95.3	143	
Total Gate Charge	Q_g			46.5	70	nC
Gate-Source Charge	Q _{gs}	V _{DS} = - 10 V, V _{GS} = - 4.5 V, I _D = - 20 A		13.7		
Gate-Drain Charge	Q _{gd}			12.5		
Gate Resistance	Rg	f = 1 MHz	0.4	1.9	3.8	Ω
Turn-On Delay Time	t _{d(on)}			19	30	
Rise Time	t _r	V_{DD} = - 10 V, R_L = 1 Ω		10	20	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong$ - 10 A, V_{GEN} = - 10 V, R_g = 1 Ω		65	98	
Fall Time	t _f			13	20	
Turn-On Delay Time	t _{d(on)}			55	83	ns
Rise Time	t _r	V_{DD} = - 10 V, R_L = 1 Ω		52	78	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong$ - 10 A, V_{GEN} = - 4.5 V, R_g = 1 Ω		53	80	
Fall Time	t _f	·		25	38	
Drain-Source Body Diode Characteris	tics					
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			- 40	
Pulse Diode Forward Current ^a	I _{SM}				- 70	A
Body Diode Voltage	V _{SD}	I _S = - 1 A		- 0.74	- 1.1	V
Body Diode Reverse Recovery Time	t _{rr}			42	63	ns
Body Diode Reverse Recovery Charge 0		1 40 A 41/41 400 A/44 T 05 00		25	38	nC
Reverse Recovery Fall Time	t _a	$I_F = -10 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$		12		ns
Reverse Recovery Rise Time	t _b			30		

Notes:

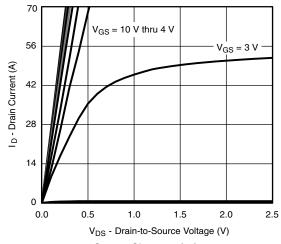
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- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

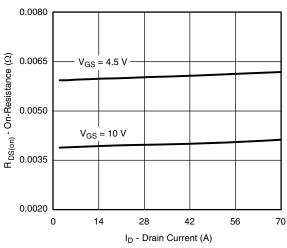
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



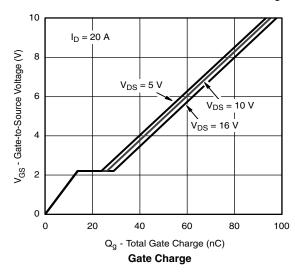
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

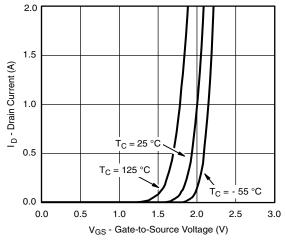


Output Characteristics

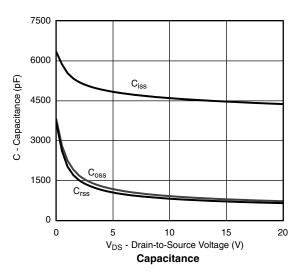


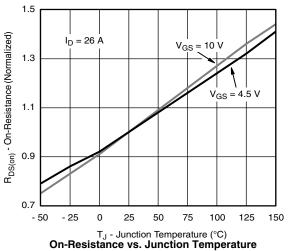
On-Resistance vs. Drain Current and Gate Voltage





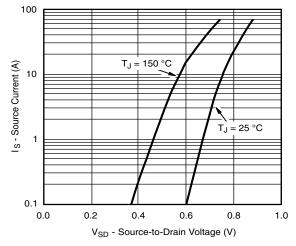
Transfer Characteristics

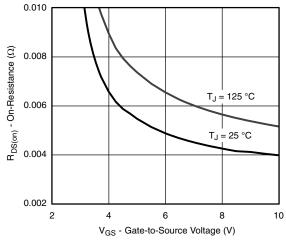




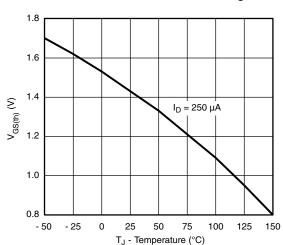


TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

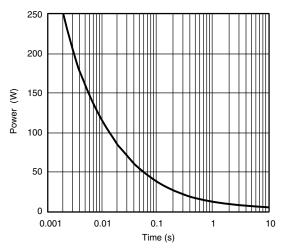




Source-Drain Diode Forward Voltage

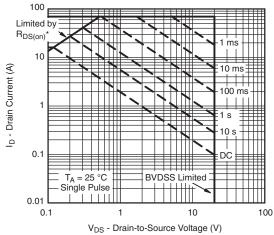


On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage

Single Pulse Power, Junction-to-Ambient

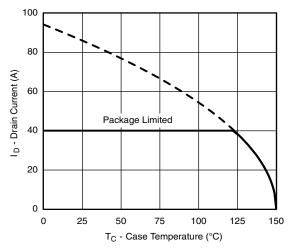


* V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

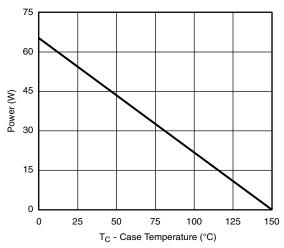
Safe Operating Area, Junction-to-Ambient

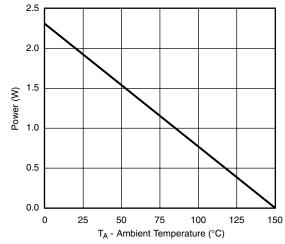


TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Current Derating*





Power, Junction-to-Case

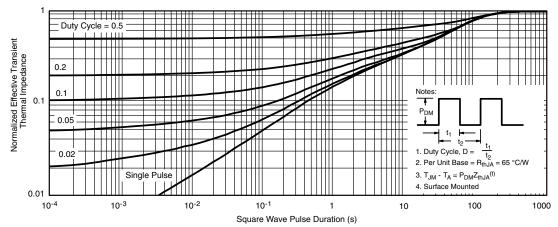
Power, Junction-to-Ambient

^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

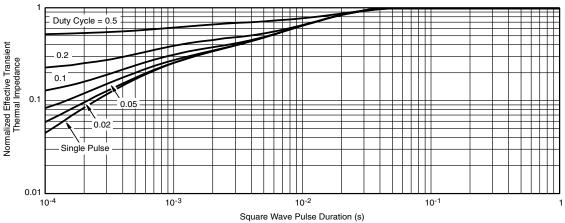
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



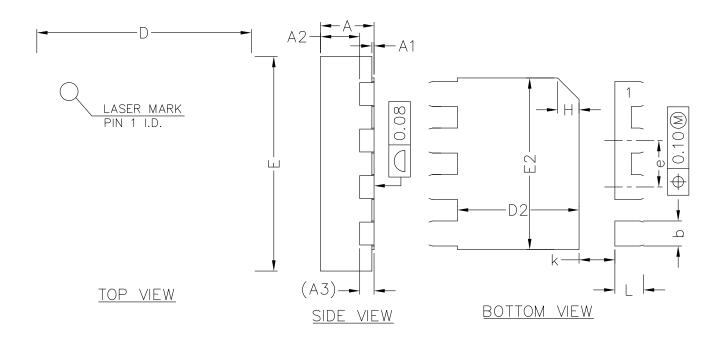
Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case



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COMMON DIMENSIONS (UNITS OF MEASURE=MILLIMETER)

SYMBOL	MIN	NOM	MAX		
Α	0.70	0.75	0.80		
A1	0.00	0.02	0.05		
A2	0.50	0.55	0.60		
A3	0.20REF				
b	0.30	0.35	0.40		
D	2.90	3.00	3.10		
Е	2.90	3.00	3.10		
D2	1.60	1.70	1.80		
E2	2.30	2.40	2.50		
е	0.55	0.65	0.75		
K	0.40	0.50	0.60		
L	0.35	0.40	0.45		



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DMN2080UCB4-7 DMN61D9UWQ-13 US6M2GTR DMN31D5UDJ-7 DMP22D4UFO-7B DMN1006UCA6-7 DMN16M9UCA6-7
STF5N65M6 IRF40H233XTMA1 STU5N65M6 DMN6022SSD-13 DMN13M9UCA6-7 DMTH10H4M6SPS-13 DMN2990UFB-7B
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